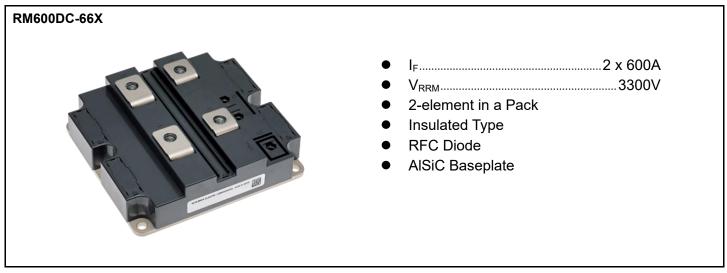


< HIGH VOLTAGE DIODE MODULES >

RM600DC-66X

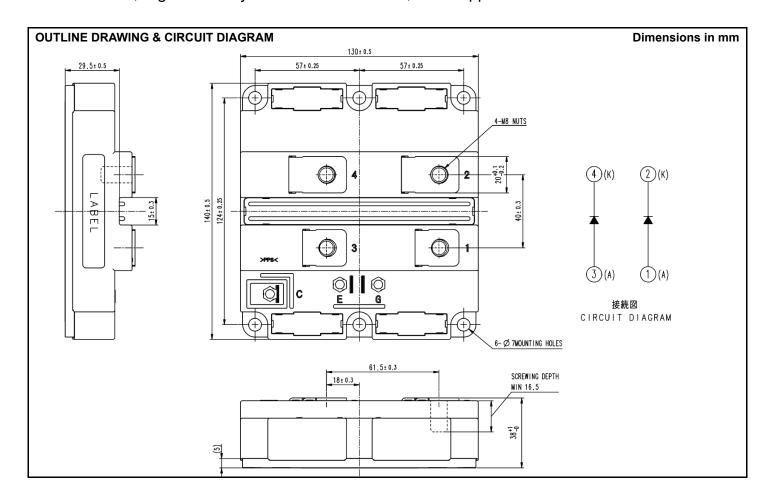
HIGH POWER SWITCHING USE INSULATED TYPE

High Voltage Diode Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



< HIGH VOLTAGE DIODE MODULES >

RM600DC-66X

HIGH POWER SWITCHING USE

INSULATED TYPE

High Voltage Diode Modules

MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V	Popotitivo poak roverso voltago	$T_j = -40+150$ °C	3300	V
V_{RRM}	Repetitive peak reverse voltage	$T_j = -50$ °C	3200	V
I _F	Forward current	DC, $T_c = 90$ °C	600	Α
I _{FSM}	Surge (non-repetitive) forward current	T = 150°C + = 10 mg Holf sing ways / = 0 //	5.8	kA
I ² t	Surge current load integral	T_{j_start} = 150°C, t_p = 10 ms, Half-sine wave, V_R = 0 V	168	kA ² s
P _{tot}	Maximum power dissipation	T _c = 25°C	3750	W
V _{iso}	Isolation voltage	RMS, sinusoidal, f = 60 Hz, t = 1 min.	6000	V
Ve	Partial discharge extinction voltage	RMS, sinusoidal, f = 60 Hz, Q _{PD} ≤ 10 pC	2600	V
T _j	Junction temperature		−50 ~ +150	°C
T _{jop}	Operating junction temperature		−50 ~ +150	°C
T_{stg}	Storage temperature		−55 ~ +150	°C

ELECTRICAL CHARACTERISTICS

Symbol	Item	Conditions		Limits			Unit
Symbol	item			Min	Тур	Max	Unit
			T _j = 25°C	_	_	1.0	
I _{RRM}	Repetitive reverse current	$V_{RM} = V_{RRM}$	T _j = 125°C	_	1.0	_	mA
			T _j = 150°C	_	6.0	_	
			T _j = 25°C	_	2.20	_	
V_{FM}	Forward voltage (Note 1)	I _F = 600 A	T _j = 125°C	_	2.40	_	V
			T _j = 150°C	_	2.50	3.00	
			T _j = 25°C	_	0.95	_	
t _{rr}	Reverse recovery time		T _j = 125°C	_	1.10	_	μs
			T _j = 150°C	_	1.15	_	
			T _j = 25°C	_	900	_	
Irr	Reverse recovery current	V _{CC} = 1800V	T _j = 125°C	_	780	_	Α
		I _F = 600 A	T _j = 150°C	_	830	_	
			T _j = 25°C	_	530	_	
Q _{rr(10%)}	Reverse recovery charge	$-d_{iF}/d_t =$	T _j = 125°C	_	800	_	μC
		2200 A/μs @ T _j = 25°C	T _j = 150°C	_	830	_	
		1950 A/μs @ Τ _j = 125°C	T _j = 25°C	_	600	_	
Q _{rr}	Reverse recovery charge	1950 A/μs @ T _i = 150°C	T _j = 125°C	_	870	_	μC
			T _j = 150°C	_	900	_	
	B	L _s = 300 nH	T _j = 25°C	_	0.55	_	
E _{rec(10%)}	Reverse recovery energy	Inductive load	T _i = 125°C	_	0.80	_	J
	per pulse (Note 2)		T _j = 150°C	_	0.90	_	
_	Davide and a second]	T _j = 25°C	_	0.60	_	
E _{rec}	Reverse recovery energy		T _j = 125°C	_	0.90	_	J
	per pulse		T _j = 150°C	_	1.00		

< HIGH VOLTAGE DIODE MODULES >

RM600DC-66X

HIGH POWER SWITCHING USE

INSULATED TYPE

High Voltage Diode Modules

THERMAL CHARACTERISTICS

Coursels al	lta va	Conditions	Limits			1.1
Symbol	ymbol Item Conditions		Min	Тур	Max	Unit
R _{th(j-c)}	Thermal resistance	Junction to Case (per 1/2 module)	-	_	33.0	K/kW
R _{th(c-s)}	Contact thermal resistance	Case to heat sink, $\lambda_{grease} = 1 \text{ W/m} \cdot \text{k}$ $D_{(c-s)} = 80 \mu \text{m} \text{ (per 1/2 module)}$	ı	25.6	_	K/kW

MECHANICAL CHARACTERISTICS

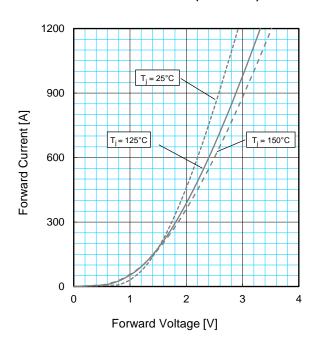
Cumbal	Item	Conditions	Limits			Unit	
Symbol	ol Item Conditions		Min	Тур	Max	Offic	
M_t	Manustin a tangua	M8 : Main terminals screw	7.0		19.0	N⋅m	
Ms	Mounting torque	M6 : Mounting screw	3.0		6.0	N⋅m	
m	Mass		1	0.9	1	kg	
CTI	Comparative tracking index		600		_	_	
d _a	Clearance		19.5		_	mm	
ds	Creepage distance		32.0	1	1	mm	
L _{PAK}	Parasitic stray inductance	1/2 module		24.0		nΗ	
R _{AA'+KK'}	Internal lead resistance	$T_c = 25^{\circ}C$, 1/2 module	1	0.27	_	mΩ	

Note 1. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note 2. The integration range of switching energies is from $E_{\text{rec}(10\%)}$ is from $10\%V_R$ to $10\%I_F$. Note 3. Definition of all items is according to IEC 60747, unless otherwise specified.

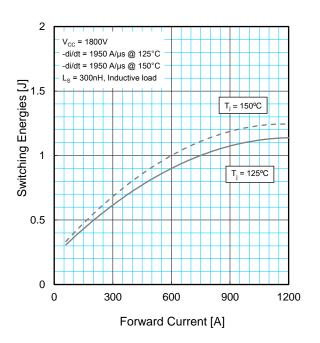
PERFORMANCE CURVES

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

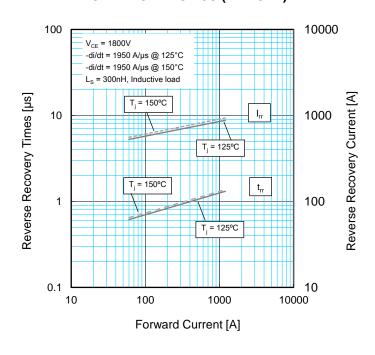


HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

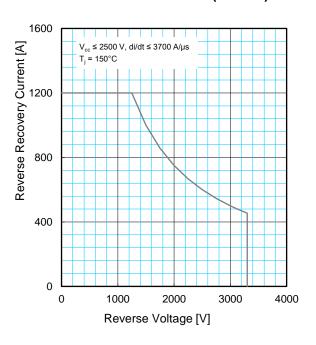
High Voltage Diode Modules



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)

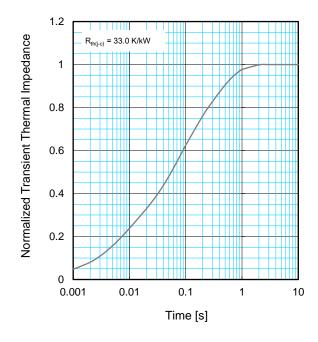


FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



PERFORMANCE CURVES

TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - \exp^{\left(-\frac{t}{\tau_{i}}\right)} \right\}$$

	1	2	3	4
R _i / R _{th(j-c)} :	0.0096	0.1893	0.4044	0.3967
τ _i [sec]:	0.0001	0.0058	0.0602	0.3512

RM600DC-66X

HIGH POWER SWITCHING USE INSULATED TYPE

High Voltage Diode Modules

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INSULATED TYPE

High Voltage Diode Modules

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